

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

 Series/Type:
 B32774H ... B32778H

 Date:
 November 2019

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Metallized Polypropylene Film Capacitors (MKP)

MKP DC link - high density THB series

B32774H ... B32778H

Typical applications

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1:2013): 40/105/56

Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- For severe ambient conditions
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible
- Extend voltage to 1600 V DC
- AEC-Q200D compliant

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 –1 mm

Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

Delivery mode

Bulk (untaped)



В32774Н ... В32778Н МКР

MKP DC link – high density THB series

Dimensional drawings

Number of wires	Lead spacing e ±0.4	Lead diameter d ₁ ±0.05	Туре
2-pin	27.5	0.8	B32774H
2-pin	37.5	1.0	B32776H
4-pin	37.5	1.2	B32776H
4-pin	52.5	1.2	B32778H

Dimensions in mm

Dimensional drawings 2-pin versions

B32774H, B32776H





		<u>.</u>
	B32774H	B32776H
Lead spacing <i>€</i> ±0.4: Lead diameter d₁:	27.5 0.8	37.5 1.0

Dimensions in mm

Dimensional drawings 4-pin versions

B32776H, B32778H







B32774H ... B32778H

 $\label{eq:mkp} \text{MKP DC link} - \text{high density THB series}$

Overview of available types

Lead spacing	27.5 mr	n							
Туре	B32774	ŀΗ							
Page	7								
V _R (V DC)	450	500	700	800	920	1100	1400	1500	1600
C _R (μF)									
0.33									
0.47									
0.56									
0.68									
0.82									
1.0									
1.2									
1.5									
1.8									
2.0									
2.2									
2.5									
2.7									
3.3									
3.9									
4.7									
5.6									
6.8									
7.5									
8.2									
10									
12									
15									
20									



B32774H ... B32778H MKP DC link – high density THB series

Overview of available types

Lead spacing	37.5 m	n							
Туре	B32776	ŝН							
Page	11								
V _R (V DC)	450	500	700	800	920	1100	1400	1500	1600
C _R (μF)									
2.0									
2.2									
2.7									
3.0									
3.3									
3.9									
4.7									
5.6									
6.8									
7.5									
8.2									
10									
12									
15									
18									
22									
27									
30									
33									
35									
39									
47									
56									
65									





B32774H ... B32778H

 $\label{eq:mkp} \text{MKP DC link} - \text{high density THB series}$

Overview of available types

Lead spacin	g 52.5 m	ım							
Туре	B3277	8H							
Page	15								
V _R (V DC)	450	500	700	800	920	1100	1400	1500	1600
C _R (μF)									
8.2									
9.0									
10									
12									
14									
15									
18									
22									
27									
30									
33									
35									
39									
47									
50									
56									
68									
75									
82									
90									
100									
120									



MKP DC link – high density THB series

MKP → 27.5 ←

Ordering codes and packing units (lead spacing 27.5 mm)

$C_B^{(1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °℃	max.	max.	taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	,	А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} °c	$_{\rm c} = 450 \text{ V DC}, \text{ V}_{\rm op,70}$	_{o°c} = 450 V DC			1	I	1	<u> </u>
3.3	$11.0 \times 19.0 \times 31.5$	B32774H4335+000	5.5	13.4	17.0	0.8	4.8	2352
3.9	$11.0 \times 21.0 \times 31.5$	B32774H4395+000	6.2	11.5	17.0	0.8	4.8	2352
4.7	$11.0 \times 21.0 \times 31.5$	B32774H4475K000	6.6	10.2	19.0	0.8	4.8	2352
5.6	$13.5 \times 23.0 \times 31.5$	B32774H4565+000	7.8	8.2	19.0	0.8	4.9	1932
6.8	$13.5 \times 23.0 \times 31.5$	B32774H4685K000	8.5	7.2	21.0	0.8	5.0	1932
8.2	$15.0 \times 24.5 \times 31.5$	B32774H4825K000	9.8	6.0	22.0	0.8	5.0	1680
10.0	$18.0 \times 27.5 \times 31.5$	B32774H4106+000	12.0	4.9	23.0	0.8	5.1	1428
12.0	$18.0 \times 27.5 \times 31.5$	B32774H4126K000	12.6	4.4	25.0	0.8	5.3	1428
15.0	$18.0 \times 33.0 \times 31.5$	B32774H4156+000	14.0	3.6	29.0	0.8	5.7	952
20.0	$22.0\times36.5\times31.5$	B32774H4206+000	14.0	3.0	31.0	0.8	6.1	784
V _{R,85} °($c = 500 \text{ V DC}, V_{op,70}$	_{o°c} = 575 V DC						
3.3	$11.0 \times 21.0 \times 31.5$	B32774H5335+000	6.2	11.9	19.0	0.8	4.2	2352
3.9	$12.5 \times 21.5 \times 31.5$	B32774H5395K000	6.6	10.4	19.0	0.8	4.3	2100
4.7	$13.5 \times 23.0 \times 31.5$	B32774H5475+000	7.6	8.7	20.0	0.8	4.3	1932
5.6	$14.0 \times 24.5 \times 31.5$	B32774H5565K000	8.6	7.4	22.0	0.8	4.4	1848
6.8	$18.0 \times 27.5 \times 31.5$	B32774H5685+000	10.5	6.2	22.0	0.8	4.5	1428
8.2	$18.0 \times 27.5 \times 31.5$	B32774H5825+000	11.5	5.3	24.0	0.8	4.6	1428
10.0	19.0 × 30.0 × 31.5	B32774H5106+000	12.5	4.5	26.0	0.8	4.7	896
12.0	$21.0 \times 31.0 \times 31.5$	B32774H5126+000	14.0	3.9	28.0	0.8	4.9	784
15.0	$22.0\times36.5\times31.5$	B32774H5156+000	14.0	3.3	32.0	0.8	5.2	784

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ K = $\pm 10\%$ Packing code:

000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

1) Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, at 10 kHz for a $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$





MKP DC link - high density THB series

Ordering codes and packing units (lead spacing 27.5 mm)

$C_R^{4)}$	Max. dimensions	Ordering code	I _{RMS,max} 5)	ESR _{typ}	ESL _{typ} ⁶⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °C	max.	max.	taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} °c	$c = 700 \text{ V DC}, V_{op,70}$	_{°C} = 800 V DC						
2.2	$11.0 \times 21.0 \times 31.5$	B32774H8225+000	5.6	14.3	18.0	0.8	3.4	2352
2.7	$12.5 \times 21.5 \times 31.5$	B32774H8275+000	6.3	12.0	19.0	0.8	3.4	2100
3.3	$13.5\times23.0\times31.5$	B32774H8335+000	7.2	9.9	20.0	0.8	3.5	1932
3.9	$14.0\times24.5\times31.5$	B32774H8395+000	8.0	8.5	21.0	0.8	3.5	1848
4.7	$15.0\times24.5\times31.5$	B32774H8475K000	8.8	7.2	23.0	0.8	3.5	1680
5.6	$18.0\times27.5\times31.5$	B32774H8565+000	11.0	5.9	24.0	0.8	3.6	1428
6.8	$19.0\times30.0\times31.5$	B32774H8685+000	12.2	5.0	25.0	0.8	3.6	896
8.2	$21.0\times31.0\times31.5$	B32774H8825+000	13.5	4.3	26.0	0.8	3.7	784
10.0	$21.0 \times 31.0 \times 31.5$	B32774H8106K000	14.0	3.8	29.0	0.8	3.8	784
12.0	$22.0\times36.5\times31.5$	B32774H8126K000	14.0	3.1	33.0	0.8	3.9	784
V _{R,85} °c	$c = 800 \text{ V DC}, V_{op,70}$	_{°C} = 900 V DC						
1.8	$11.0 \times 21.0 \times 31.5$	B32774H9185+000	5.3	15.6	18.0	0.8	3.1	2352
2.2	$12.5 \times 21.5 \times 31.5$	B32774H9225+000	6.0	13.2	19.0	0.8	3.1	2100
2.7	$13.5 \times 23.0 \times 31.5$	B32774H9275+000	6.8	10.8	20.0	0.8	3.1	1932
3.3	$14.0 \times 24.5 \times 31.5$	B32774H9335K000	8.0	8.9	22.0	0.8	3.1	1848
3.9	$18.0 \times 27.5 \times 31.5$	B32774H9395+000	9.5	7.6	22.0	0.8	3.1	1428
4.7	$18.0 \times 27.5 \times 31.5$	B32774H9475+000	10.5	6.4	24.0	0.8	3.2	1428
5.6	$19.0\times30.0\times31.5$	B32774H9565+000	12.0	5.4	25.0	0.8	3.2	896
6.8	$21.0 \times 31.0 \times 31.5$	B32774H9685+000	13.0	4.5	27.0	0.8	3.3	784
8.2	$22.0\times36.5\times31.5$	B32774H9825+000	14.0	3.9	31.0	0.8	3.3	784
10.0	$22.0\times36.5\times31.5$	B32774H9106K000	14.0	3.4	33.0	0.8	3.4	784

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

$$\mathsf{J}=\pm 5\%$$

K = ±10%

Packing code:

000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

4) Capacitance value measured at 1 kHz

⁵⁾ Max ripple current I_{RMS} at 70 °C, at 10 kHz for a $\Delta T \le 20$ °C at $\Delta ESR_{typ} \le \pm 5\%$



MKP DC link – high density THB series

MKP 27.5 ◀

Ordering codes and packing units (lead spacing 27.5 mm)

C _B ⁷⁾	Max. dimensions	Ordering code	8)	ESR _{typ}	ESL _{typ} ⁹⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	I _{RMS,max} ⁸⁾ 70 °C	70 °C	70 °C	max.	max.	taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
F		below)						
μF	mm		A	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} °c	$_{2} = 920 \text{ V DC}, \text{ V}_{\text{op},70}$	_{0°C} = 1100 V DC	-		-		-	
1.8	$12.5 \times 21.5 \times 31.5$	B32774H0185+000	5.8	14.2	19.0	0.8	2.8	2100
2.2	$13.5\times23.0\times31.5$	B32774H0225+000	6.5	12.0	20.0	0.8	2.8	1932
2.7	$15.0\times24.5\times31.5$	B32774H0275K000	7.6	9.8	22.0	0.8	2.8	1680
3.3	$18.0\times27.5\times31.5$	B32774H0335+000	9.3	8.1	23.0	0.8	2.8	1428
3.9	$18.0 \times 27.5 \times 31.5$	B32774H0395+000	10.0	7.0	24.0	0.8	2.9	1428
4.7	$19.0\times30.0\times31.5$	B32774H0475+000	11.5	5.8	26.0	0.8	2.9	896
5.6	$21.0\times31.0\times31.5$	B32774H0565+000	12.8	4.9	28.0	0.8	3.0	784
6.8	$22.0\times36.5\times31.5$	B32774H0685+000	14.0	4.1	31.0	0.8	3.0	784
7.5	$22.0\times36.5\times31.5$	B32774H0755+000	14.0	3.8	33.0	0.8	3.0	784
V _{R,85} °c	$_{\rm c} = 1100 \text{ V DC}, \text{ V}_{\rm op,70}$	_{0°c} = 1300 V DC						
1.5	$13.5 \times 23.0 \times 31.5$	B32774H1155+000	6.0	13.8	21.0	0.8	2.2	1932
1.8	$14.0 \times 24.5 \times 31.5$	B32774H1185K000	7.0	11.6	22.0	0.8	2.2	1848
2.2	$18.0 \times 27.5 \times 31.5$	B32774H1225+000	8.6	9.4	23.0	0.8	2.2	1428
2.7	$18.0\times27.5\times31.5$	B32774H1275+000	9.5	7.9	25.0	0.8	2.3	1428
3.3	$19.0\times30.0\times31.5$	B32774H1335+000	10.8	6.5	27.0	0.8	2.3	896
3.9	$21.0 \times 31.0 \times 31.5$	B32774H1395K000	12.0	5.7	28.0	0.8	2.3	784
4.7	$22.0\times36.5\times31.5$	B32774H1475+000	13.0	4.7	31.0	0.8	2.4	784
V _{R,85} °c	$_{c} = 1400 \text{ V DC}, \text{ V}_{op,70}$	_{°C} = 1500 V DC						
0.47	$11.0 \times 21.0 \times 31.5$	B32774H2474+000	3.7	33.0	18.0	0.8	1.7	2352
0.56	$11.0 \times 21.0 \times 31.5$	B32774H2564+000	4.1	27.7	19.0	0.8	1.7	2352
0.68	$12.5 \times 21.5 \times 31.5$	B32774H2684K000	4.6	22.8	20.0	0.8	1.7	2100
0.82	$13.5 \times 23.0 \times 31.5$	B32774H2824+000	5.5	19.2	21.0	0.8	1.7	1848
1.0	$15.0 \times 24.5 \times 31.5$	B32774H2105+000	6.0	15.9	22.0	0.8	1.8	1680
1.5	$19.0 \times 30.0 \times 31.5$	B32774H2155+000	8.5	10.9	25.0	0.8	1.8	896
2.0	21.0 × 31.0 × 31.5	B32774H2205+000	10.0	8.5	28.0	0.8	1.8	784
2.2	22.0 × 36.5 × 31.5	B32774H2225+000	11.0	7.7	29.0	0.8	1.8	784
2.7	$22.0\times36.5\times31.5$	B32774H2275K000	12.0	6.5	33.0	0.8	1.9	784

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

$$\mathsf{J}=\pm5\%$$

 $K = \pm 10\%$

Packing code:

000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

⁷⁾ Capacitance value measured at 1 kHz

⁸⁾ Max ripple current I_{RMS} at 70 °C, at 10 kHz for a ΔT ≤20 °C at ΔESR_{typ} ≤±5%





MKP DC link - high density THB series

Ordering codes and packing units (lead spacing 27.5 mm)

$C_{R}^{10)}$	Max. dimensions	Ordering code	I _{RMS,max} ¹¹⁾	ESR _{typ}	ESL _{typ} ¹²⁾	$tan \delta$	tan δ	Un-
	$w \times h \times I$	(composition see	70 °C	70 °C	70 °C	max.	max.	taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} °c								
0.47	$11.0\times21.0\times31.5$	B32774H6474+000	3.8	32.0	18.0	0.8	1.6	2352
0.56	$12.5 \times 21.5 \times 31.5$	B32774H6564+000	4.3	26.2	19.0	0.8	1.6	2100
0.68	$13.5\times23.0\times31.5$	B32774H6684+000	5.0	21.7	20.0	0.8	1.6	1932
0.82	$14.0\times24.5\times31.5$	B32774H6824+000	5.6	18.2	22.0	0.8	1.6	1848
1.0	$18.0 \times 27.5 \times 31.5$	B32774H6105+000	7.0	15.0	22.0	0.8	1.6	1428
1.2	$18.0\times27.5\times31.5$	B32774H6125+000	7.5	12.6	24.0	0.8	1.6	1428
1.5	$19.0\times30.0\times31.5$	B32774H6155+000	8.8	10.3	26.0	0.8	1.7	896
1.8	$21.0\times31.0\times31.5$	B32774H6185+000	9.8	8.7	28.0	0.8	1.7	784
2.0	$22.0\times36.5\times31.5$	B32774H6205+000	11.0	7.8	30.0	0.8	1.7	784
2.2	$22.0\times36.5\times31.5$	B32774H6225+000	11.5	7.3	31.0	0.8	1.7	784
2.5	$22.0\times36.5\times31.5$	B32774H6255K000	12.0	6.8	34.0	0.8	1.8	784
V _{R,85} °C	$_{\rm c} = 1600 \text{ V DC}, \text{ V}_{\rm op,70}$	_{°C} = 1700 V DC						
0.33	$11.0 \times 21.0 \times 31.5$	B32774H7334+000	3.3	41.9	17.0	0.8	1.5	2352
0.47	$12.5 \times 21.5 \times 31.5$	B32774H7474+000	4.1	29.8	18.0	0.8	1.5	2100
0.56	$13.5\times23.0\times31.5$	B32774H7564+000	4.6	25.0	19.0	0.8	1.5	1932
0.68	$14.0\times24.5\times31.5$	B32774H7684+000	5.3	20.6	21.0	0.8	1.5	1848
0.82	$18.0\times27.5\times31.5$	B32774H7824+000	6.5	17.4	22.0	0.8	1.5	1428
1.0	$18.0\times27.5\times31.5$	B32774H7105+000	7.0	14.3	23.0	0.8	1.5	1428
1.5	$21.0\times31.0\times31.5$	B32774H7155+000	9.0	9.8	27.0	0.8	1.6	784
2.0	$22.0\times36.5\times31.5$	B32774H7205+000	11.0	7.6	33.0	0.8	1.6	784
2.2	$22.0\times36.5\times31.5$	B32774H7225K000	11.6	7.0	34.0	0.8	1.7	784

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

$$J = \pm 5\%$$

 $K = \pm 10\%$

Packing code:

000 = untaped (lead length 6 - 1 mm) Other lead lengths available upon request

10) Capacitance value measured at 1 kHz

11) Max ripple current I_{RMS} at 70 °C, at 10 kHz for a ΔT ≤20 °C at ΔESR_{typ} ≤±5%



MKP DC link – high density THB series

MKP → 37.5 ◄

Ordering codes and packing units (lead spacing 37.5 mm)

$C_R^{(1)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} 2)	ESR _{typ}	ESL _{typ} ³⁾	$tan \delta$	tan δ	Un-
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	max.	max.	taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$V_{R,85\ ^{\circ}C} = 450\ V\ DC,\ V_{op,70\ ^{\circ}C} = 450\ V\ DC$									<u> </u>
15.0	$16.0\times28.5\times42.0$	_	B32776H4156+000	8.5	11.1	20.0	2.0	17.5	800
18.0	$18.0 \times 32.5 \times 42.0$	—	B32776H4186+000	10.0	9.4	21.0	2.0	17.5	720
22.0	$18.0\times32.5\times42.0$	—	B32776H4226K000	11.0	7.8	23.0	2.0	17.6	720
27.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H4276+000	13.6	6.2	11.0	2.0	17.6	640
30.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H4306+000	14.5	5.6	12.0	2.0	17.6	640
33.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H4336+000	16.2	5.1	10.0	2.0	17.8	440
35.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H4356+000	16.8	4.8	11.0	2.0	17.8	440
39.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H4396+000	18.0	4.4	11.0	2.0	18.0	440
47.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H4476+000	20.0	3.6	13.0	2.0	18.0	440
56.0	$30.0\times45.0\times42.0$	20.3*)	B32776H4566+000	23.0	3.1	14.0	2.0	18.1	440
65.0	$33.0\times48.0\times42.0$	20.3*)	B32776H4656+000	26.0	2.7	15.0	2.0	18.3	180
V _{R,85} °	$v_{\rm C} = 500 \text{ V DC}, V_{\rm op,7}$	• _{0 °C} =	575 V DC						
10.0	$16.0\times28.5\times42.0$	_	B32776H5106+000	7.5	14.3	19.0	1.7	15.0	800
12.0	$16.0 \times 28.5 \times 42.0$	—	B32776H5126K000	8.2	12.1	21.0	1.7	15.1	800
15.0	$18.0\times32.5\times42.0$	—	B32776H5156+000	9.8	9.7	22.0	1.7	15.2	720
18.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H5186+000	12.0	7.9	10.0	1.7	15.0	640
22.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H5226+000	13.3	6.5	12.0	1.7	15.0	640
27.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H5276+000	16.0	5.3	11.0	1.7	15.0	440
30.0	$28.0 \times 42.5 \times 42.0$	10.2 ^{*)}	B32776H5306+000	17.5	4.8	12.0	1.7	15.1	440
33.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H5336+000	18.2	4.4	12.0	1.7	15.2	440
39.0	$30.0\times45.0\times42.0$	20.3*)	B32776H5396+000	20.5	3.8	13.0	1.7	15.3	440
47.0	$33.0\times48.0\times42.0$	20.3*)	B32776H5476+000	24.0	3.1	14.0	1.7	15.5	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

*) 2-pin version available on request

Composition of ordering code

 $J = \pm 5\%$ K = $\pm 10\%$ Packing code: 000 = untaped (lead length 6 - 1 mm)

Other lead lengths available upon request

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, at 10 kHz for a $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)



MKP DC link - high density THB series

Ordering codes and packing units (lead spacing 37.5 mm)

$C_R^{4)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} 5)	ESR _{typ}	ESL _{typ} ⁶⁾	$tan \delta$	tan δ	Un-
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	max.	max.	taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} °	$_{\rm C} = 700 \text{ V DC}, \text{ V}_{\rm op,7}$	_{0 °C} =	800 V DC						
5.6	$14.0\times25.0\times42.0$	_	B32776H8565K000	5.6	21.8	17.0	1.4	12.4	1380
6.8	$16.0\times28.5\times42.0$	—	B32776H8685+000	6.8	17.3	18.0	1.4	12.5	800
8.2	$16.0\times28.5\times42.0$	—	B32776H8825+000	7.5	14.6	20.0	1.5	12.5	800
10.0	$18.0\times32.5\times42.0$	_	B32776H8106+000	8.8	12.0	21.0	1.5	12.6	720
12.0	$18.0\times32.5\times42.0$	—	B32776H8126K000	9.5	10.5	23.0	1.5	12.7	720
15.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H8156+000	12.0	7.9	11.0	1.4	12.4	640
18.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H8186+000	14.2	6.1	10.0	1.4	12.5	440
22.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H8226K000	15.5	5.5	11.0	1.5	12.6	440
27.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H8276K000	17.5	4.6	13.0	1.5	12.7	440
35.0	$33.0\times48.0\times42.0$	20.3*)	B32776H8356+000	22.5	3.5	14.0	1.5	12.8	180
V _{R,85} °	$_{\rm C} = 800 \text{ V DC}, \text{ V}_{\text{op},7}$	_{0 °C} = 3	900 V DC						
3.9	$14.0\times25.0\times42.0$	—	B32776H9395+000	5.0	26.9	16.0	1.3	11.0	1380
4.7	$14.0\times25.0\times42.0$	_	B32776H9475+000	5.5	22.3	18.0	1.3	11.0	1380
5.6	$16.0\times28.5\times42.0$	_	B32776H9565+000	6.5	18.8	19.0	1.3	11.1	800
6.8	$16.0\times28.5\times42.0$	—	B32776H9685K000	7.2	15.5	20.0	1.3	11.1	800
8.2	$18.0\times32.5\times42.0$	—	B32776H9825+000	8.5	13.1	22.0	1.3	11.2	720
10.0	$18.0\times32.5\times42.0$	—	B32776H9106K000	9.2	11.2	24.0	1.3	11.2	720
12.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H9126+000	11.5	8.8	11.0	1.3	11.0	640
15.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H9156+000	13.8	7.0	11.0	1.3	11.1	440
18.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H9186+000	15.5	5.9	12.0	1.3	11.1	440
22.0	$30.0\times45.0\times42.0$	20.3*)	B32776H9226+000	18.0	4.9	13.0	1.3	11.2	400
27.0	$33.0\times48.0\times42.0$	20.3*)	B32776H9276+000	21.0	4.0	14.0	1.3	11.3	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

*) 2-pin version available on request

Composition of ordering code

+ =	Capacitance tolerance code:	Packing code:
	$J=\pm5\%$	000 = untaped (lead length 6 -1 mm)
	$K = \pm 10\%$	Other lead lengths available upon request

5) Max ripple current I_{RMS} at 70 °C, at 10 kHz for a $\Delta T \le 20$ °C at $\Delta ESR_{typ} \le \pm 5\%$



MKP DC link – high density THB series

MKP → 37.5 ◄

Ordering codes and packing units (lead spacing 37.5 mm)

$C_{R}^{7)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} 8)	ESR _{typ}	ESL _{typ} ⁹⁾	$tan \delta$	tan δ	Un-
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	max.	max.	taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} °	$_{\rm C} = 920 \text{ V DC}, \text{ V}_{\rm op,7}$	_{°°C} = 1	100 V DC		<u> </u>		•		
3.3	$14.0\times25.0\times42.0$	_	B32776H0335+000	5.0	28.2	16.0	1.2	9.8	1380
3.9	$14.0\times25.0\times42.0$	—	B32776H0395K000	5.3	24.8	18.0	1.2	9.8	1380
4.7	$16.0\times28.5\times42.0$	—	B32776H0475+000	6.4	20.1	19.0	1.2	9.9	800
5.6	$16.0\times28.5\times42.0$	—	B32776H0565K000	7.0	16.8	21.0	1.2	9.9	800
6.8	$18.0\times32.5\times42.0$	—	B32776H0685+000	8.2	13.9	22.0	1.2	10.0	720
8.2	$18.0\times32.5\times42.0$	—	B32776H0825K000	8.8	12.2	24.0	1.2	10.0	720
10.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H0106+000	11.0	9.4	11.0	1.2	9.9	640
12.0	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H0126+000	13.0	7.9	11.0	1.2	9.9	440
15.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H0156+000	15.0	6.4	12.0	1.2	10.0	440
18.0	$30.0\times45.0\times42.0$	20.3*)	B32776H0186+000	17.5	5.4	13.0	1.2	10.1	400
22.0	$33.0\times48.0\times42.0$	20.3*)	B32776H0226+000	20.0	4.4	14.0	1.2	10.2	180
V _{R,85} °	$_{\rm C}$ = 1100 V DC, V _{op,7}	_{0 °C} = 1	300 V DC				-		
2.7	$16.0\times28.5\times42.0$	—	B32776H1275+000	5.4	27.8	17.0	1.0	7.9	800
3.3	$16.0\times28.5\times42.0$	—	B32776H1335+000	6.0	22.8	19.0	1.0	8.0	800
3.9	$16.0\times28.5\times42.0$	—	B32776H1395K000	6.3	20.5	21.0	1.0	8.0	800
4.7	$18.0\times32.5\times42.0$	—	B32776H1475+000	7.6	16.3	22.0	1.0	8.0	720
5.6	$20.0\times 39.5\times 42.0$	10.2 ^{*)}	B32776H1565+000	9.3	13.3	10.0	1.0	7.9	640
6.8	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H1685+000	10.2	11.0	11.0	1.0	7.9	640
8.2	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H1825+000	12.0	9.2	11.0	1.0	7.9	440
10.0	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H1106+000	14.0	7.6	12.0	1.0	7.9	440
12.0	$30.0\times45.0\times42.0$	20.3*)	B32776H1126+000	16.0	6.4	13.0	1.0	8.0	400
15.0	$33.0\times48.0\times42.0$	20.3*)	B32776H1156+000	18.5	5.2	14.0	1.0	8.1	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

*) 2-pin version available on request

Composition of ordering code

+ =	Capacitance tolerance code:	Packing code:
	$J=\pm5\%$	000 = untaped (lead

 $K = \pm 10\%$

Packing code: 000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

7) Capacitance value measured at 1 kHz

⁸⁾ Max ripple current I_{RMS} at 70 °C, at 10 kHz for a $\Delta T \le 20$ °C at $\Delta ESR_{typ} \le \pm 5\%$



MKP DC link - high density THB series

Ordering codes and packing units (lead spacing 37.5 mm)

$C_{R}^{10)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ¹¹	ESR _{typ}	ESL _{typ} ¹²	han δ	tan δ	Un-
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	max.	max.	taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm	,	А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
·	_C = 1400 V DC, V _{op,7}	_{0°c} = 1	500 V DC	<u> </u>	<u> </u>				<u> </u>
3.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H2305+000	8.5	17.0	10.0	0.8	5.3	640
3.3	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H2335+000	9.0	15.3	10.0	0.8	5.4	640
3.9	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H2395+000	9.8	13.1	12.0	0.8	5.5	640
4.7	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H2475K000	11.0	11.6	11.0	0.8	5.7	440
5.6	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H2565+000	12.5	9.8	12.0	0.8	5.7	440
6.8	$30.0\times45.0\times42.0$	20.3 ^{*)}	B32776H2685+000	14.5	8.0	14.0	0.8	5.7	400
7.5	$33.0\times48.0\times42.0$	20.3*)	B32776H2755+000	16.0	7.3	14.0	0.8	5.8	180
8.2	$33.0\times48.0\times42.0$	20.3 ^{*)}	B32776H2825+000	16.5	6.8	14.0	0.8	5.8	180
V _{R,85} °	$_{\rm C}$ = 1500 V DC, V _{op,7}	_{0 °c} = 1	600 V DC	_	-			-	
2.2	$18.0\times32.5\times42.0$	—	B32776H6225+000	6.5	23.4	22.0	0.8	5.3	720
3.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H6305+000	8.5	16.9	11.0	0.8	5.4	640
3.3	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H6335+000	9.0	15.4	12.0	0.8	5.4	640
3.9	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H6395+000	10.5	13.2	11.0	0.8	5.4	440
4.7	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H6475+000	11.5	10.9	12.0	0.8	5.4	440
5.6	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H6565K000	12.5	9.5	13.0	0.8	5.4	440
6.8	$33.0\times48.0\times42.0$	20.3 ^{*)}	B32776H6685+000	15.5	7.6	14.0	0.8	5.5	180
7.5	$33.0\times48.0\times42.0$	20.3*)	B32776H6755+000	16.5	7.0	15.0	0.8	5.5	180
V _{R,85} °	$_{\rm C} = 1600 \text{ V DC}, \text{ V}_{\rm op,7}$	₀ ° _C = 1	700 V DC		1			1	
2.0	$18.0\times32.5\times42.0$	—	B32776H7205+000	6.5	22.9	22.0	0.8	4.8	720
2.7	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H7275+000	8.5	16.7	11.0	0.8	4.8	640
3.0	$20.0\times39.5\times42.0$	10.2 ^{*)}	B32776H7305+000	8.8	15.3	12.0	0.8	4.8	640
3.3	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H7335+000	10.0	13.6	10.0	0.8	4.8	440
3.9	$28.0\times37.0\times42.0$	10.2 ^{*)}	B32776H7395K000	10.8	11.7	11.0	0.8	4.8	440
4.7	$28.0\times42.5\times42.0$	10.2 ^{*)}	B32776H7475+000	12.0	9.7	13.0	0.8	4.9	440
5.6	$30.0\times45.0\times42.0$	20.3*)	B32776H7565K000	14.0	8.2	14.0	0.8	4.9	400
6.8	$33.0\times48.0\times42.0$	20.3*)	B32776H7685K000	16.5	6.7	15.0	0.8	4.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

^{*)} 2-pin version available on request

Composition of ordering code

+ = Capacitance tolerance code:

J = ±5% K = ±10% Packing code: 000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

10) Capacitance value measured at 1 kHz

11) Max ripple current I_{RMS} at 70 °C, at 10 kHz for a $\Delta T \leq$ 20 °C at $\Delta ESR_{typ} \leq \pm 5\%$



B32778H

MKP DC link – high density THB series

MKP → 52.5 →

Ordering codes and packing units (lead spacing 52.5 mm, $P_1 = 20.3$ mm)

$\overline{C_R^{1)}}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	70 °C	70 °Č	70 °Ĉ	max.	max.	taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} ° _C	= 450 V DC, V _{op,70} °C	e = 450 V DC	•		•		1	
75.0	$30.0\times45.0\times57.5$	B32778H4756+000	21.5	4.5	13.0	3.8	35.6	280
82.0	$30.0\times45.0\times57.5$	B32778H4826K000	22.0	4.2	14.0	3.8	35.7	280
90.0	$35.0\times50.0\times57.5$	B32778H4906+000	24.5	3.8	14.0	3.8	36.2	108
100.0	$35.0\times50.0\times57.5$	B32778H4107+000	26.5	3.5	15.0	3.8	36.2	108
120.0	$38.0\times57.5\times57.5$	B32778H4127+000	29.5	2.9	16.0	3.9	36.7	96
V _{R,85} °C	= 500 V DC, $V_{op,70°C}$	e = 575 V DC						
50.0	$30.0\times45.0\times57.5$	B32778H5506+000	19.0	5.6	13.0	3.2	30.0	280
56.0	$30.0\times45.0\times57.5$	B32778H5566+000	20.0	5.1	13.0	3.2	30.1	280
68.0	$35.0\times50.0\times57.5$	B32778H5686+000	23.5	4.2	14.0	3.2	30.4	108
75.0	$35.0\times50.0\times57.5$	B32778H5756+000	25.0	3.9	15.0	3.2	30.6	108
82.0	$38.0\times57.5\times57.5$	B32778H5826+000	27.0	3.6	16.0	3.3	30.7	96
90.0	$38.0\times57.5\times57.5$	B32778H5906+000	28.0	3.3	17.0	3.3	30.9	96
V _{R,85} ° _C	= 700 V DC, $V_{op,70}$ °C	= 800 V DC						
39.0	$30.0\times45.0\times57.5$	B32778H8396+000	18.0	6.2	13.0	2.7	25.2	280
47.0	$30.0\times45.0\times57.5$	B32778H8476K000	19.5	5.4	14.0	2.7	25.4	280
50.0	$35.0\times50.0\times57.5$	B32778H8506+000	22.0	4.9	14.0	2.7	25.5	108
56.0	$35.0\times50.0\times57.5$	B32778H8566+000	23.0	4.4	15.0	2.7	25.6	108
68.0	$38.0\times57.5\times57.5$	B32778H8686+000	26.5	3.6	17.0	2.8	26.0	96
75.0	$38.0\times57.5\times57.5$	B32778H8756K000	27.5	3.4	18.0	2.8	26.1	96
V _{R,85} ° _C	= 800 V DC, $V_{op,70}$ °C	= 900 V DC						
35.0	$30.0\times45.0\times57.5$	B32778H9356+000	18.0	6.2	14.0	2.4	22.4	280
39.0	$35.0\times50.0\times57.5$	B32778H9396+000	20.5	5.5	14.0	2.4	22.5	108
47.0	$35.0\times50.0\times57.5$	B32778H9476K000	22.5	4.7	16.0	2.4	22.6	108
50.0	$38.0\times57.5\times57.5$	B32778H9506+000	24.5	4.3	17.0	2.5	22.7	96
56.0	$38.0\times57.5\times57.5$	B32778H9566+000	26.0	3.9	18.0	2.5	22.9	96

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code: 000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, at 10 kHz for a ΔT ≤20 °C at ΔESR_{typ} ≤±5%
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





B32778H

MKP DC link - high density THB series

Ordering codes and packing units (lead spacing 52.5 mm, $P_1 = 20.3$ mm)

$C_R^{4)}$	Max. dimensions	Ordering code	I _{RMS,max} 5)	ESR _{typ}	ESL _{typ} ⁶⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °C	max.	max.	taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm		А	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,85} ° _C	= 920 V DC, V _{op,70} °C	= 1100 V DC						
27.0	30.0 × 45.0 × 57.5	B32778H0276+000	17.0	7.1	13.0	2.2	20.0	280
30.0	30.0 imes 45.0 imes 57.5	B32778H0306K000	17.5	6.7	14.0	2.2	20.0	280
33.0	$35.0\times50.0\times57.5$	B32778H0336+000	20.0	5.8	15.0	2.2	20.2	108
35.0	$35.0\times50.0\times57.5$	B32778H0356+000	21.0	5.5	15.0	2.2	20.2	108
39.0	$35.0\times50.0\times57.5$	B32778H0396K000	21.5	5.1	16.0	2.2	20.3	108
47.0	$38.0\times57.5\times57.5$	B32778H0476+000	23.5	4.2	18.0	2.2	20.5	96
V _{R,85} ° _C	= 1100 V DC, V _{op,70} °C	c = 1300 V DC						
18.0	$30.0\times45.0\times57.5$	B32778H1186+000	15.5	8.5	13.0	1.8	16.0	280
22.0	$35.0\times50.0\times57.5$	B32778H1226+000	18.0	7.0	14.0	1.8	16.1	108
27.0	$35.0\times50.0\times57.5$	B32778H1276K000	20.0	6.0	15.0	1.8	16.2	108
30.0	$38.0\times57.5\times57.5$	B32778H1306+000	22.5	5.2	17.0	1.8	16.3	96
33.0	$38.0\times57.5\times57.5$	B32778H1336K000	23.0	4.9	18.0	1.8	16.4	96
V _{R,85} ° _C	= 1400 V DC, V _{op,70} °C	c = 1500 V DC						
9.0	$30.0\times45.0\times57.5$	B32778H2905+000	13.5	11.5	14.0	1.3	10.9	280
10.0	$30.0\times45.0\times57.5$	B32778H2106+000	14.5	10.4	14.0	1.3	10.9	280
12.0	$35.0\times50.0\times57.5$	B32778H2126+000	17.0	8.8	14.0	1.3	11.0	108
15.0	$38.0\times57.5\times57.5$	B32778H2156+000	20.0	7.0	16.0	1.3	11.0	96
18.0	$38.0\times57.5\times57.5$	B32778H2186K000	21.5	6.1	18.0	1.3	11.0	96
V _{R,85} ° _C	= 1500 V DC, V _{op,70} °C	c = 1600 V DC						
8.2	$30.0\times45.0\times57.5$	B32778H6825+000	13.5	11.9	13.0	1.2	10.2	280
9.0	$30.0\times45.0\times57.5$	B32778H6905+000	14.0	10.9	13.0	1.2	10.2	280
10.0	$35.0\times50.0\times57.5$	B32778H6106+000	16.0	9.8	14.0	1.2	10.3	108
12.0	$35.0\times50.0\times57.5$	B32778H6126+000	17.5	8.2	15.0	1.2	10.3	108
15.0	$38.0\times57.5\times57.5$	B32778H6156+000	20.5	6.6	17.0	1.3	10.4	96
V _{R,85} ° _C	= 1600 V DC, V _{op,70} °C	c = 1700 V DC						
8.2	$30.0\times45.0\times57.5$	B32778H7825K000	13.5	11.3	13.0	1.1	9.7	280
10.0	$35.0\times50.0\times57.5$	B32778H7106+000	16.5	9.3	15.0	1.1	9.7	108
12.0	$38.0\times57.5\times57.5$	B32778H7126+000	19.0	7.8	16.0	1.1	9.8	96
14.0	$38.0\times57.5\times57.5$	B32778H7146+000	20.5	6.7	18.0	1.1	9.8	96

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

Composition of ordering code

- + = Capacitance tolerance code:
 - $J = \pm 5\%$
 - $K = \pm 10\%$

Packing code:

000 = untaped (lead length 6 -1 mm) Other lead lengths available upon request

4) Capacitance value measured at 1 kHz

5) Max ripple current I_{RMS} at 70 °C, at 10 kHz for a ΔT <20 °C at ΔESR_{typ} <±5%

6) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)

Please read Cautions and warnings and Important notes at the end of this document.



B32774H ... B32778H

MKP DC link – high density THB series

Technical data

Reference standard: IEC 61071:2007 and AEC-Q200D. All data given at T = 20 $^{\circ}$ C, unless otherwise specified.

wise specified.										
Rated temperature	T _R	+85 °	С							
Operating tempera	ture range (case)	Max.	operat	ing ter	npera	ture, T	op,max		+105	°C
		Upper category temperature T _{max}							+105 °C	
		Lowe	r categ	gory te	mpera	ture T	min		-40	°C
Insulation resistance	ce R _{ins}	τ > 10) 000 s	s (after	1 min	.)				
given as time cons	tant	For V	_R ≥ 50	0 V me	easure	d at 50	V 00			
$\tau = C_R \cdot R_{ins}$, rel. hu	umidity $\leq 65\%$	For V	_R < 50	0 V me	easure	d at V	R			
(minimum as-delive	ered values)									
DC test voltage be	tween terminals (10 s)	1.5 ·	V _R							
Voltage test termin	al to case (10 s)	2110	VAC,	50 Hz						
Pulse Handling Ca	pability (V/µs)	$I_{P}(A)$	/ C (µl	F)						
Reliability:	Failure rate λ	10 fit	(≤ 10	· 10 ⁻⁹ /ł	n) at 0	.5 · V _P	, 40 °0)		
		For conversion to other operating conditions and								
		tempe	erature	es, refe	er to ch	napter	"Quali	ty, 2 R	eliabili	ty".
	Service life t _{SL}	50 000 h at V _R and 85 °C								
Advanced biased h	numidity ¹⁾	1000 hours / 60 °C / 95% relative humidity with $V_{\text{R,DC}}$								
Limit values after te	est	Capacitance change $ \Delta C/C \leq 5\%$								
		Dissip	oation	factor	chang	e Δ tar	ıδ ≤	≤ 200 %	6 (at 10) kHz)
		Insula	ation re	esistan	ce R _{ins}	8	2	≥ 100 N	ΩN	
V _R (V DC)		450	500	700	800	920	1100	1400	1500	1600
Continuous operati	ing voltage									
V_{op} (V DC) at 70 °C)	450	575	800	900	1100	1300	1500	1600	1700
Continuous operati	ing voltage									
V _{op} (V DC) at 85 °C			500	700	800	920	1100	1400	1500	1600
For temperatures b	1.33%/°C of V_{op} derating compared to V_{op} at 85 °C									
85 °C and 105 °C										

1) 1000 hours / 85 $^\circ C$ / 85% RH with $V_{\scriptscriptstyle R}$ available on request, based on special design.

Typical waveforms







B32774H ... B32778H

MKP DC link - high density THB series

Restrictions:

 V_{R} : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\hat{v}_{AC} \le 0.2 \cdot V_{R} (V_{R} \le 1100 \text{ V DC})$ $\hat{v}_{AC} \le 0.15 \cdot V_{R} (V_{R} \le 1400 \text{ V DC})$

Overvoltage	Maximum duration within one day	Observation		
1.1 · V _R	30% of on-load duration	System regulation		
1.15 · V _R	30 min.	System regulation		
1.2 · V _R	5 min.	System regulation		
1.3 · V _R	1 min.	System regulation		

NOTE 1 An overvoltage equal to $1.5 \cdot V_R$ for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

Lead spacing	27.5 mm	27.5 mm							
Туре	B32774								
V _R (V DC)	450	500	700	800	920	1100	1400	1500	1600
dV/dt in V/µs	30	35	40	50	75	100	140	145	155

Lead spacing	37.5 mn	37.5 mm							
Туре	B32776								
V _R (V DC)	450	500	700	800	920	1100	1400	1500	1600
dV/dt in V/µs	21	22	22	35	54	73	100	105	110

Lead spacing	52.5 mm								
Туре	B32778								
V _R (V DC)	450	500	700	800	920	1100	1400	1500	1600
dV/dt in V/µs	14	14	15	22	35	50	65	70	75

Please read *Cautions and warnings* and *Important notes* at the end of this document.





MKP → 27.5 ◄

MKP DC link - high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC



Impedance Z versus frequency f

(typical values)



500 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm







Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

700 V DC



Impedance Z versus frequency f

(typical values)



800 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm

700 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm





27.5



MKP DC link – high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

920 V DC



Impedance Z versus frequency f

(typical values)



1100 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm

920 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm

1100 V DC



www.tdk-electronics.tdk.com.





Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

1400 V DC



Impedance Z versus frequency f

(typical values)



1500 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm

1400 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm







MKP MKP DC link - high density THB series 27.5 🔫

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

1600 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm







Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

450 V DC



Impedance Z versus frequency f (typical values)



500 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

450 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm





37.5



MKP DC link – high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

700 V DC



Impedance Z versus frequency f (typical values)



800 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

700 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm







Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

920 V DC



Impedance Z versus frequency f (typical values)



1100 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

920 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm





37.5



MKP DC link – high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1400 V DC



Impedance Z versus frequency f (typical values)



1500 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1400 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm







Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1600 V DC



ESR versus frequency f (typical values)

(typical values)

Lead spacing 37.5 mm





52.5



MKP DC link – high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC



Impedance Z versus frequency f

(typical values)



500 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm







Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

700 V DC



Impedance Z versus frequency f

(typical values)



800 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

700 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm





52.5



MKP DC link – high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

920 V DC



Impedance Z versus frequency f

(typical values)



1100 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

920 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm







Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

1400 V DC



Impedance Z versus frequency f

(typical values)



1500 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm

1400 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm





52.5



MKP DC link – high density THB series

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

1600 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm







Permissible current I_{RMS} versus frequency f at 70 $^\circ\text{C}$

Lead spacing 27.5 mm











MKP DC link – high density THB series

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 27.5 mm

700 V DC









Permissible current I_{RMS} versus frequency f at 70 $^\circ\text{C}$

Lead spacing 27.5 mm

920 V DC








MKP DC link – high density THB series

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 27.5 mm

1400 V DC









Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 27.5 mm







MKP 37.5

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm











Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm











MKP → 37.5 →

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm











Permissible current I_{RMS} versus frequency f at 70 $^\circ\text{C}$

Lead spacing 37.5 mm

1400 V DC









MKP DC link – high density THB series

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm







Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 52.5 mm

450 V DC









BH MKP es 52.5

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 $^\circ\text{C}$

Lead spacing 52.5 mm

700 V DC









Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 52.5 mm

920 V DC







B32778H MKP DC link – high density THB series

MKP → 52.5 ←

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 $^\circ\text{C}$

Lead spacing 52.5 mm











Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 52.5 mm







Curves characteristics (I_{RMS} derating versus temperature)



Maximum I_{RMS} current as function of the ambient temperature: I_{RMS} (T_A) = Factor × I_{RMS} (70 °C)





MKP DC link - high density THB series

Heat transference for self heating calculation



The equivalent heat coefficient "**G** (**mW**/°**C**)" is given for measuring the temperature on the lateral surface of the plastic box as figure1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.



MKP

B32774H ... B32778H

MKP DC link – high density THB series

Self Heating by power dissipation & equivalent heat coefficient

The I_{RMS} and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of ΔT allowed for this series. ΔT_{max} given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per:

 ΔT_{max} (T) = (Factor)² × ΔT (70 °C).

For any particular I_{RMS} the ΔT may be calculated by:

 $\Delta T (^{\circ}C) = P_{dis} (mW) / G(mW/^{\circ}C).$

Where ΔT (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T (^{\circ}C) = T_{op} (^{\circ}C) - T_{A} (^{\circ}C).$$

It represents the increasing of temperature provoked by the I_{RMS} during operation. G (mW/°C) is the equivalent heat coefficient described above and P_{dis} (mW) is the dissipated power defined by: P_{dis} (mW) = ESR_{typ} (mΩ) × I_{rms}² (A_{RMS}).

Example for thermal calculation:

We will take as reference B32778H0306K (30 μ F/920 V DC) type for thermal calculation. Considering the following load and capacitor characteristics:

$$\begin{split} I_{\text{RMS}} &:\; 12 \; A_{\text{RMS}} \; \text{at 20 kHz} \\ T_{\text{A}} &:\; 85 \; ^{\circ}\text{C} \\ 30 \times 45 \times 57.5 \; \text{box} \\ \text{G} \; (\text{mW/}^{\circ}\text{C}) &:\; 125 \end{split}$$

Then we have to find the ESR_{typ} at 20 kHz what is approx . 8.2 m Ω . So according to:

 $P_{dis} (mW) = ESR_{typ} (m\Omega) \times I_{rms}^2 (A_{RMS})$

we have the following:

 P_{dis} (mW) = 8.2 m $\Omega \times 12 A_{BMS}^2$ = 1181 mW

and as per:

 $\Delta T (^{\circ}C) = P_{dis} (mW) / G (mW/^{\circ}C)$

we have the following:

 ΔT (°C) = 1181 (mW) / 125 (mW/°C) = 9.5 °C.

What is below of the

 ΔT_{max} (85 °C) = (Factor)² × ΔT (70 °C) = (0.7)² × 20 °C = 9.8 °C.

On the other hand we may confirm as page 46 that max I_{RMS} at 20 kHz at 70 °C = 17.5 A_{RMS} .

And then max I_{RMS} for 85 °C of ambient temperature is defined as follows:

 I_{RMS} (85 °C) = Factor × I_{RMS} (70 °C) = 0.7 × 17.5 A_{RMS} = 12.3 A_{RMS} .

What confirms once again that I_{RMS} (12 A_{RMS} at 20 kHz) is below the max specified for such frequency and ambient temperature.





MKP DC link – high density THB series

Life time expectancy - typical curves

B3277*H4 (450 V DC)



B3277*H5/8/9/0/1 (500 V DC / 700 V DC / 800 V DC / 920 V DC / 1100 V DC)



Note: Confidence level of 95%





B32774H ... B32778H MKP DC link – high density THB series

Life time expectancy - typical curves

B3277*-H2/6/7 (1400 V DC / 1500 V DC / 1600 V DC)







 $\label{eq:mkp} \text{MKP DC link} - \text{high density THB series}$

Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical parameters (Routine test)	IEC 61071:2007	Voltage between terminals, 1.5 V _R , during 10 s Insulation resistance, R _{ins} at V _R if V _R < 500 V or 500 V if V _R \ge 500 V Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan δ at 1/10 kHz (room temperature)		Within specified limits
Robustness of termina- tions (Type test)	IEC 60068-2-21:2006	Tensile strength (tes Wire diameter $0.5 < d_1 \le 0.8$ mm $0.8 < d_1 \le 1.25$ mm	t Ua1) Tensile force 10 N 20 N	Capacitance and tan δ within specified limits
Change of temperature (Type test)	IEC 61071:2007	T_A = lower category temperature; T_B = upper category temperature; 5 cycles, duration t = 30 min.		$\begin{array}{l} \mbox{Electrical:} \\ \Delta C/C_0 \leq 2\% \mbox{ at 1 kHz} \\ \Delta \mbox{ tan } \delta \leq 0.002 \\ \hline R_{ins} \geq 50\% \mbox{ of initial limit} \\ \hline \mbox{Mechanical:} \\ \mbox{ No visible damage} \end{array}$
Resistance to soldering heat (Type test)	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temperature at , 260 ±5 °C, immersion for 10 seconds		$\begin{array}{l} \Delta C/C_0 \leq 2\% \text{ at 1 kHz} \\ \Delta \tan \delta \leq 0.002 \\ R_{ins} \geq 50\% \text{ of initial limit} \\ \text{Mechanical:} \\ \text{No visible damage} \end{array}$
Vibration and shocks (Type test)	IEC 61071:2007	In accordance with IEC 60068-2-6 f = 10 Hz to 55 Hz a = ± 0.35 mm Test duration per axis = 10 frequency cycles (3 axes offset from each other by 90°), 1 octave/min.		Electrical: $ \Delta C/C_0 \le 0.5\%$ at 1 kHz Mechanical: No visible damage
		Mounting conditions: The capacitor shall be fixed by the leads and the body must be properly clamped.		



MKP DC link - high density THB series

MKP

Test	Reference	Conditions of test	Performance requirements
Climatic sequence (Type test)	IEC 60384-16:2005	Dry heat Tb / 16 h Damp heat cyclic, 1 st cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH	$\label{eq:linear} \begin{array}{l} \mbox{No visible damage} \\ \Delta C/C_0 \leq 3\% \\ \Delta \mbox{ tan } \delta \leq 0.001 \\ R_{ins} \geq 50\% \mbox{ of initial limit} \end{array}$
Endurance (Type test)	IEC 61071:2007	+85 °C / 1.3 V_R / 500 hours and 1000 discharges at 1.4 I_R and +85 °C / 1.3 V_R / 500 hours	$\begin{array}{l} \mbox{Electrical:} \\ \Delta C/C_0 \ \pm 3\% \\ \Delta \ tan \ \delta \le 0.015 \\ R_{ins} \ge 50\% \ of \ initial \ limit \\ \hline \ \mbox{Mechanical:} \\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $
Biased humidity test (Type test)	AEC-Q200:2010	V _R / 40 °C / 93% RH / 1000 hours	Electrical: $ \Delta C/C_0 \le 5\%$ $ \Delta \tan \delta/\Delta \tan \delta \le 200\%$ (10 kHz)
			$R_{ins} \ge 50\%$ of initial limit Mechanical: No visible damage
		V _R / 60 °C / 95% RH / 1000 hours ¹⁾	Electrical: $ \Delta C/C_0 \le 5\%$ $ \Delta \tan \delta/\Delta \tan \delta \le 200\%$ (10 kHz)
			$\label{eq:Rins} \begin{array}{l} R_{\text{ins}} \geq 100 \ \text{M}\Omega \\ \\ \hline \text{Mechanical:} \\ \text{No visible damage} \end{array}$

1) 1000 hours / 85 $^\circ\text{C}$ / 85% RH with V_{R} available on request, based on special design.





Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C	
Soldering time	2.0 ±0.5 s	
Immersion depth	2.0 +0/ -0.5 mm from capacitor body or seating plane	
Evaluation criteria:		
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder	

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1. Conditions:

Series		Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case 2.5 \times 6.5 \times 7.2 mm)		5±1 s
MKP MKT	(lead spacing ≤7.5 mm) uncoated (lead spacing ≤10 mm) insulated (B32559)		<4 s recommended soldering profile for MKT uncoated (lead spacing \leq 10 mm) and insulated (B32559)

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B32774H ... B32778H MKP DC link – high density THB series



Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 \pm 0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_{o}$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
tan δ	As specified in sectional specification

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings





The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



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KMK1744-9-E





MKP DC link – high density THB series

B32774H ... B32778H

Body temperature should follow the description below:

- MKP capacitor During pre-heating: T_p ≤110 °C During soldering: T_s ≤120 °C, t_s ≤45 s
- MKT capacitor During pre-heating: T_p ≤125 °C During soldering: T_s ≤160 °C, t_s ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be \leq 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.





MKP DC link - high density THB series

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



MKP DC link – high density THB series

MKP

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

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www.tdk-electronics.tdk.com/orderingcodes.

Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.





 $\label{eq:mkp} \text{MKP DC link} - \text{high density THB series}$

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{c}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β _c	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f ₂	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F⊤	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



MKP

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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k ₀	Pulse characteristic	Impulskennwert
L _S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R _i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
R _s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T _{op}	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _B	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer





 $\label{eq:mkp} \text{MKP DC link} - \text{high density THB series}$

Symbol	English	German
V _{AC}	AC voltage	Wechselspannung
V _c	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
Ŷ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
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